1.0X0.5mm SMD CHIP LED LAMP

Part Number: APHHS1005SURCK Hyper Red

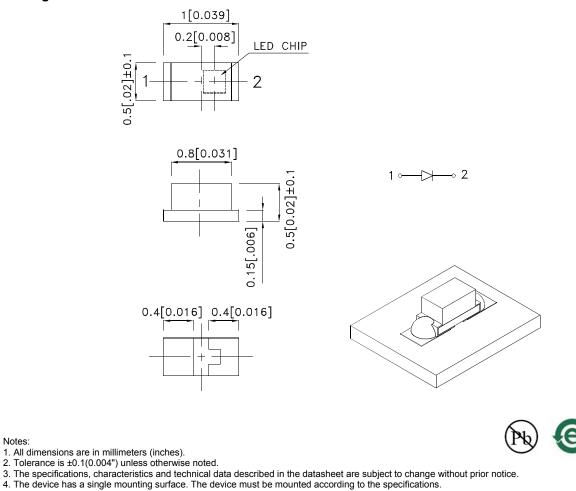
Features

- 1.0mmX0.5mm SMT LED, 0.5mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GalnP on GaAs substrate Light Emitting Diode.

Package Dimensions



SPEC NO: DSAN3511 APPROVED: WYNEC REV NO: V.1A CHECKED: Allen Liu DATE: NOV/16/2013 DRAWN: Q.M.Chen PAGE: 1 OF 5 ERP: 1203001434

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA			Viewing Angle [1]
			Code	Min.	Max.	201/2
APHHS1005SURCK	Hyper Red (AlGaInP)		Р	200	300	120°
		Weter Olean	Q	300	400	
		Water Clear	*H	*55	*80	
			*M	*80	*120	

Notes: 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%. * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

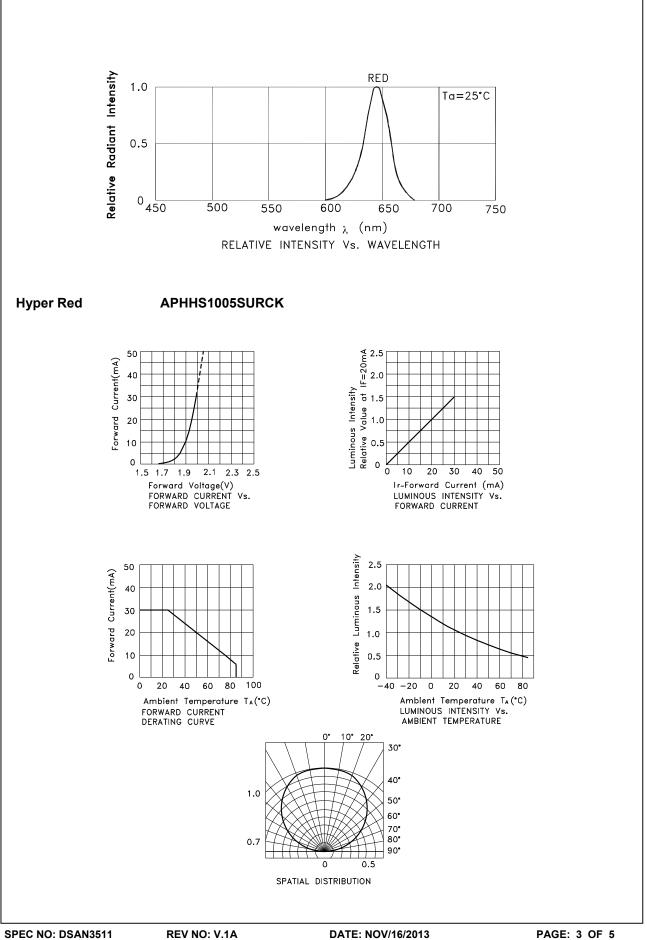
Symbol	Parameter	Device	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red		645		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red	620		640	nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red		28		nm	I⊧=20mA
С	Capacitance	Hyper Red		35		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Hyper Red		1.95	2.5	V	I⊧=20mA
lr	Reverse Current	Hyper Red			10	uA	VR=5V

Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V. 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	185	mA		
Reverse Voltage	5	V		
Electrostatic Discharge Threshold (HBM)	3000	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

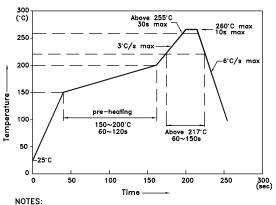
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



APHHS1005SURCK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



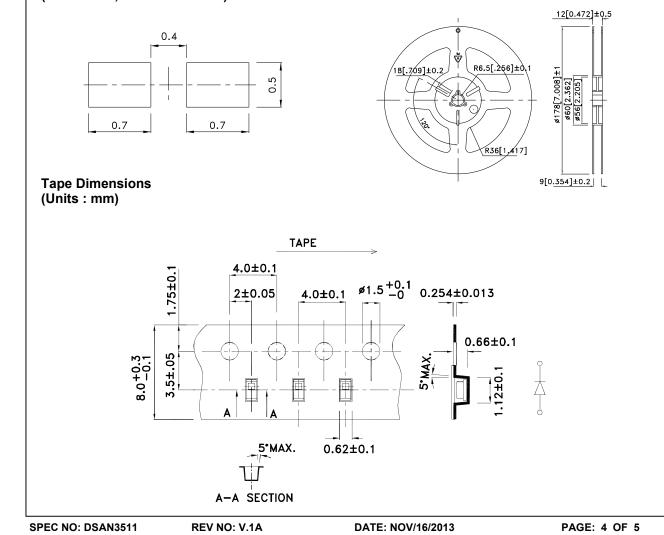
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Reflow soldering should not be done more than two times.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

APPROVED: WYNEC

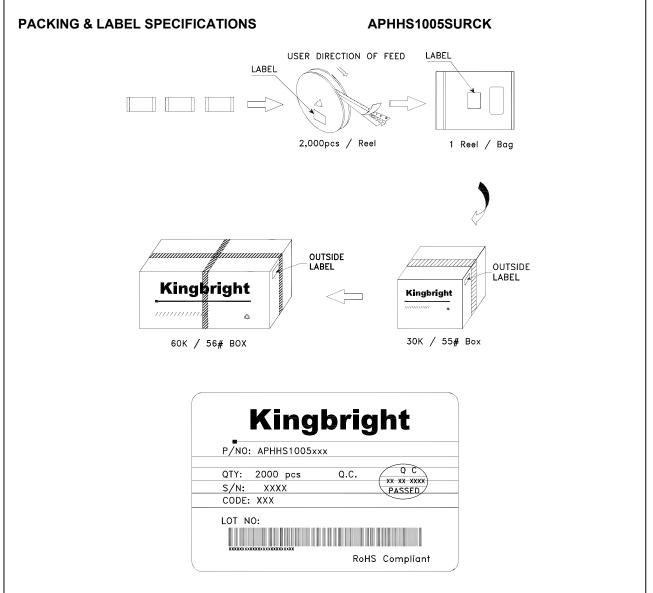
Reel Dimension



DRAWN: Q.M.Chen

CHECKED: Allen Liu

ERP: 1203001434



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